

N-Channel Enhancement Mode Power MOSFET

<p>Description</p> <p>The G2312 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge. It can be used in a wide variety of applications.</p> <p>General Features</p> <ul style="list-style-type: none"> ● V_{DS} 20V ● I_D (at $V_{GS} = 10V$) 5A ● $R_{DS(ON)}$ (at $V_{GS} = 10V$) < 18mΩ ● $R_{DS(ON)}$ (at $V_{GS} = 4.5V$) < 20mΩ ● 100% Avalanche Tested ● RoHS Compliant <p>Application</p> <ul style="list-style-type: none"> ● Power switch ● DC/DC converters 	<p>Schematic diagram</p> <p>Marking and pin assignment</p> <p>SOT-23</p>		
Device	Package	Marking	Packaging
G2312	SOT-23	G2312	3000pcs/Reel

Absolute Maximum Ratings $T_C = 25^\circ\text{C}$, unless otherwise noted			
Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	20	V
Continuous Drain Current	I_D	5	A
Pulsed Drain Current (note1)	I_{DM}	20	A
Gate-Source Voltage	V_{GS}	± 12	V
Power Dissipation	P_D	1.25	W
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 To 150	$^\circ\text{C}$

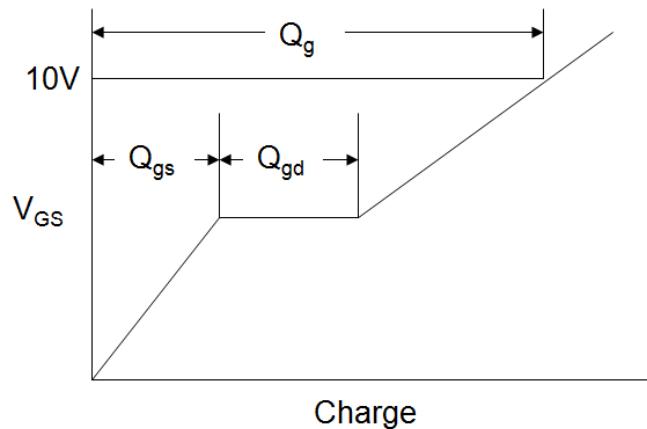
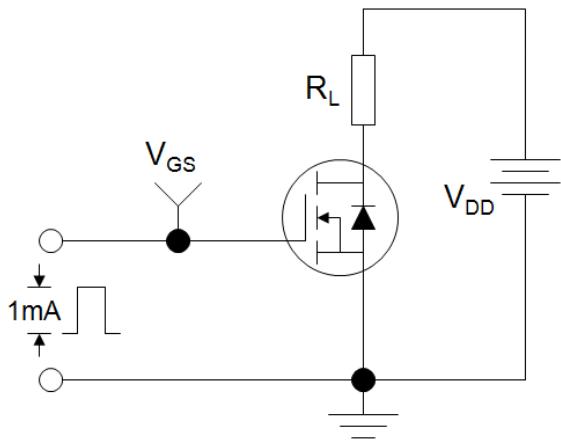
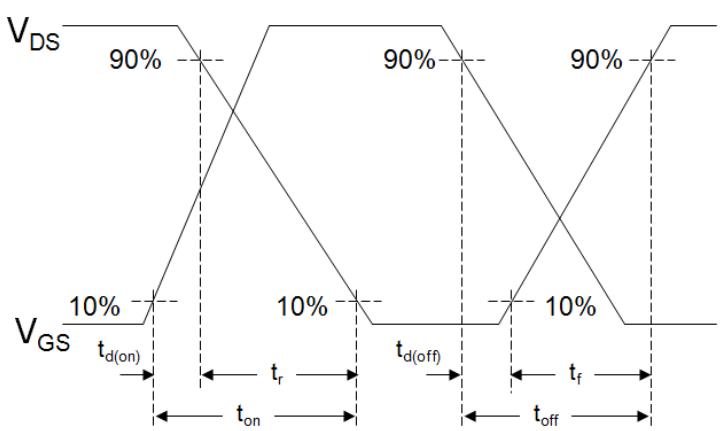
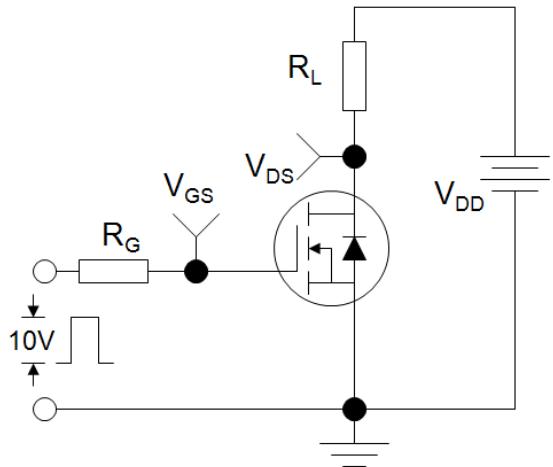
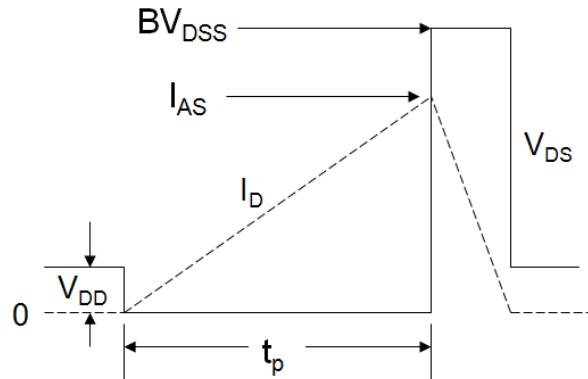
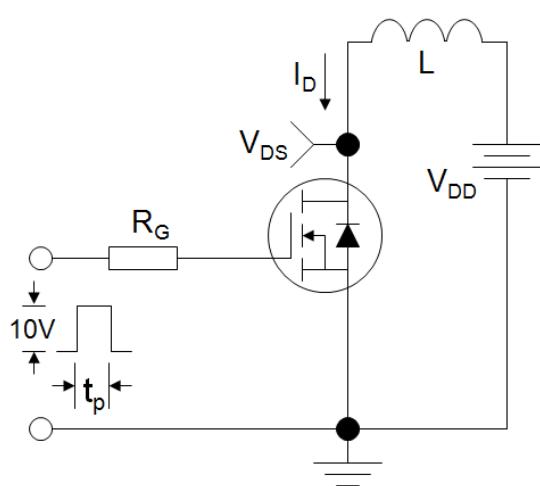
Thermal Resistance			
Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Ambient	R_{thJA}	100	$^\circ\text{C/W}$

Specifications $T_J = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
Static Parameters						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	20	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = 20\text{V}, V_{\text{GS}} = 0\text{V}$	--	--	1	μA
Gate-Source Leakage	I_{GSS}	$V_{\text{GS}} = \pm 12\text{V}$	--	--	± 100	nA
Gate-Source Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	0.4	0.7	1	V
Drain-Source On-Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_D = 4.2\text{A}$	--	12	18	$\text{m}\Omega$
		$V_{\text{GS}} = 4.5\text{V}, I_D = 4\text{A}$	--	13	20	
		$V_{\text{GS}} = 2.5\text{V}, I_D = 1\text{A}$	--	14	27	
Forward Transconductance	g_{FS}	$V_{\text{DS}}=15\text{V}, I_D=5\text{A}$	25	--	--	S
Dynamic Parameters						
Input Capacitance	C_{iss}	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 10\text{V}, f = 1.0\text{MHz}$	--	780	--	pF
Output Capacitance	C_{oss}		--	140	--	
Reverse Transfer Capacitance	C_{rss}		--	80	--	
Total Gate Charge	Q_g	$V_{\text{DD}} = 10\text{V}, I_D = 5\text{A}, V_{\text{GS}} = 4.5\text{V}$	--	11	--	nC
Gate-Source Charge	Q_{gs}		--	2.3	--	
Gate-Drain Charge	Q_{gd}		--	2.9	--	
Turn-on Delay Time	$t_{d(\text{on})}$	$V_{\text{DD}} = 10\text{V}, I_D = 1\text{A}, R_G = 6\Omega$	--	9	--	ns
Turn-on Rise Time	t_r		--	30	--	
Turn-off Delay Time	$t_{d(\text{off})}$		--	35	--	
Turn-off Fall Time	t_f		--	10	--	
Drain-Source Body Diode Characteristics						
Continuous Body Diode Current	I_S	$T_C = 25^\circ\text{C}$	--	--	5	A
Body Diode Voltage	V_{SD}	$T_J = 25^\circ\text{C}, I_{\text{SD}} = 1\text{A}, V_{\text{GS}} = 0\text{V}$	--	--	1.2	V

Notes

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. Identical low side and high side switch with identical R_G

Gate Charge Test Circuit**Switch Time Test Circuit****EAS Test Circuit**

Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 1. Output Characteristics

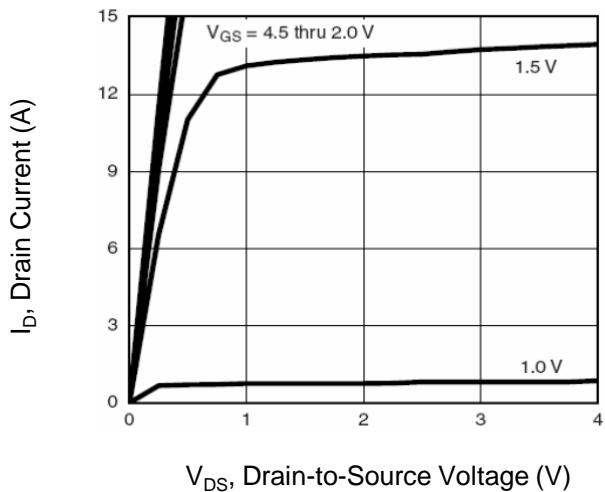


Figure 2. Transfer Characteristics

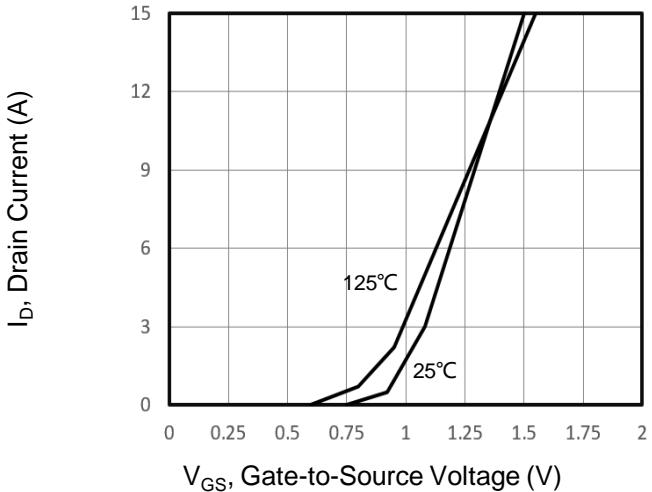


Figure 3. Gate Charge

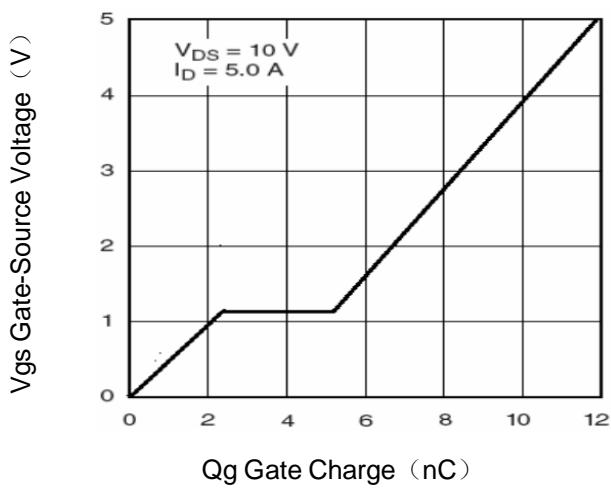


Figure 4. Drain Source On Resistance

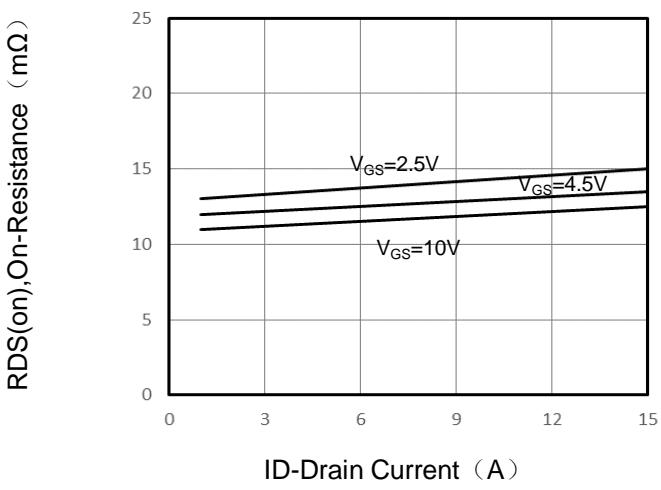


Figure 5. Capacitance

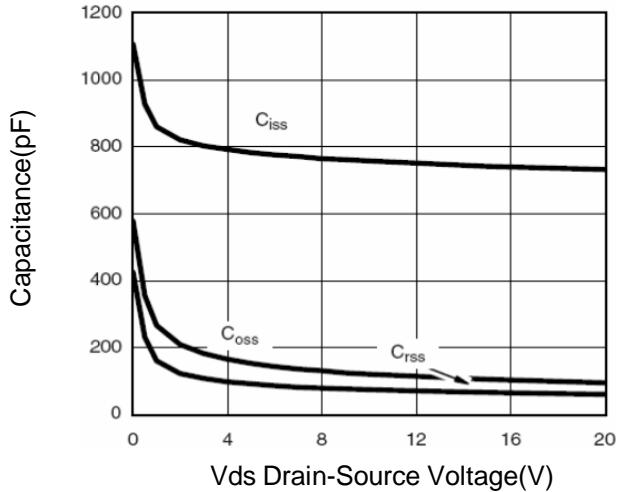
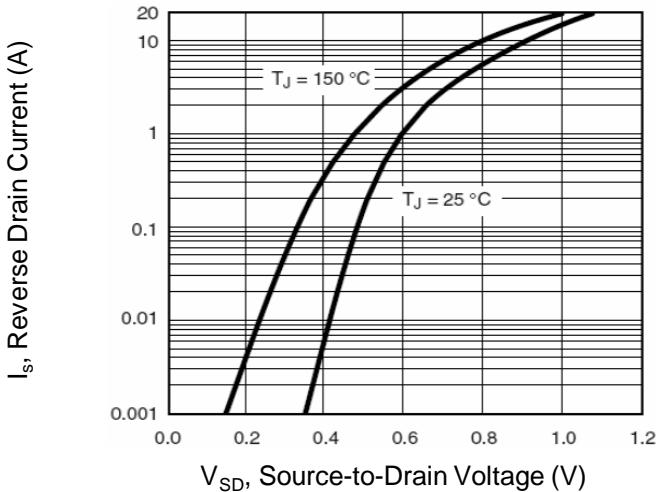


Figure 6. Source-Drain Diode Forward



Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 7. Drain-Source On-Resistance

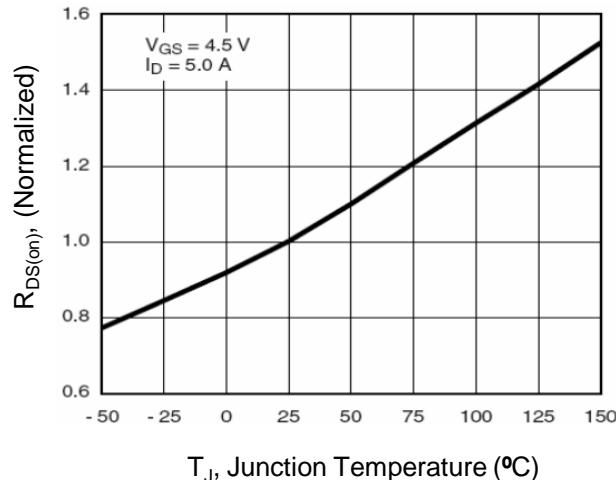


Figure 8. Safe Operation Area

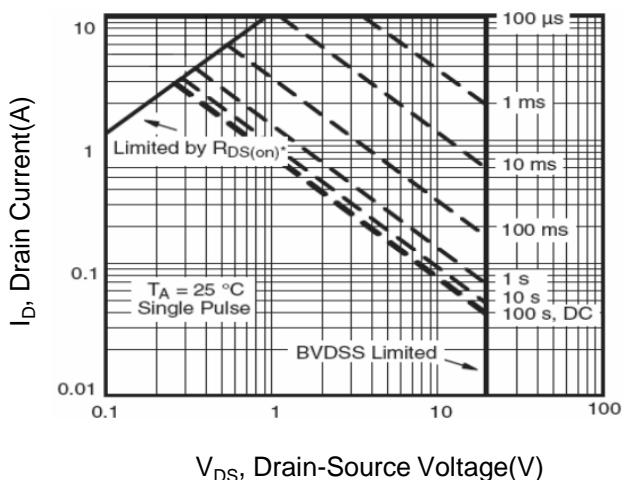
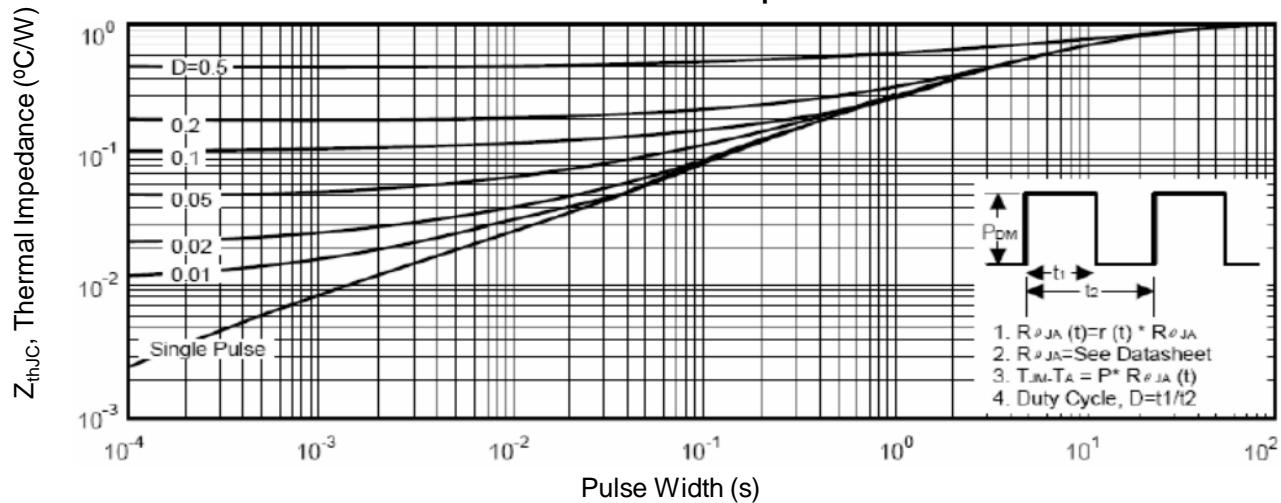
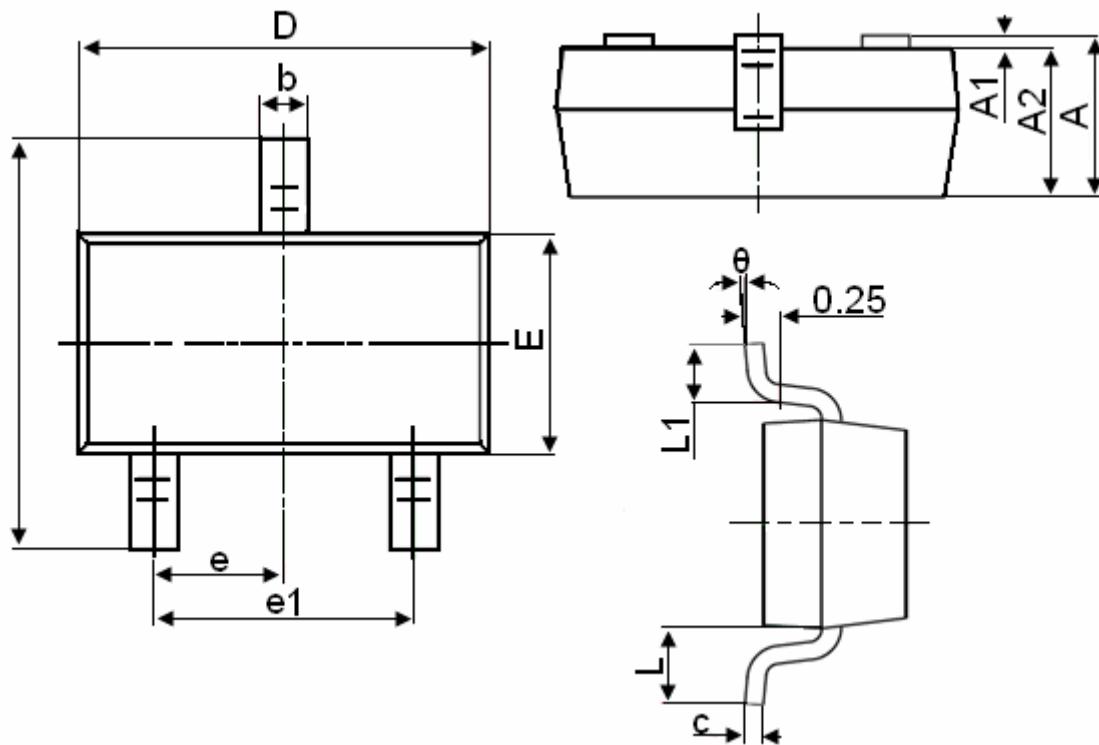


Figure 9. Normalized Maximum Transient Thermal Impedance



SOT-23 Package Information



Symbol	Dimensions in Millimeters	
	MIN.	MAX.
A	0.900	1.150
A1	0.000	0.100
A2	0.900	1.050
b	0.300	0.500
c	0.080	0.150
D	2.800	3.000
E	1.200	1.400
E1	2.250	2.550
e	0.950TYP	
e1	1.800	2.000
L	0.550REF	
L1	0.300	0.500
θ	0°	8°

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